IN THE CLAIMS:

1. (Original) A method of manufacturing a substrate (10) comprising the steps of applying a resist (13) to at least a part of a metallic layer (12) on a first side of a substantially transparent polymeric film (11), removing metal from areas not covered by the resist (13) to form demetallised regions, characterized in that the resist (13) is darkly coloured and in that a layer of polymeric liquid crystal material (15) over the resist (13) and the demetallised regions.

- (Original) A method as claimed in claim 1 in which the resist
 (13) contains a dye or pigment which is black or dark.
- 3. **(Currently amended)** A method as claimed in claim 1 or claim 2, further comprising the step of applying a substantially clear resist (15) to at least another part of the metallic layer (12).
- 4. (Currently amended) A method as claimed in any one of the preceding claims claim 1 in which the removal of metal in the demetallisation process is carried out with a caustic wash.
- 5. (Currently amended) A method as claimed in any one of the preceding claims claim 1 in which negative indicia (14) are formed by the demetallised regions.
- 6. (Currently amended) A method as claimed in any one of the claims 1 to 4 claim 1 in which positive indicia (14) are formed by the resist covered regions.
- 7. **(Currently amended)** A method as claimed in any one of the preceding claims claim 1 in which the polymeric liquid crystal layer (15) is applied by a coating process.

8. (Currently amended) A method as claimed in any one of claims 1 to 6 claim 1 in which the polymeric liquid crystal layer (15) is applied by a transfer process.

- 9. **(Currently amended)** A method as claimed in any one of claims 1 to 6 claim 1 in which the polymeric liquid crystal layer (15) applied by a lamination process.
- 10. (Currently amended) A method as claimed in any-one of the preceding claims claim 1 in which the resist (13) incorporates a conducting material to produce a machine-readable conducting layer.
- 11. **(Currently amended)** A method as claimed in any one of the preceding claims claim 1 in which the resist (13) incorporates magnetic material to produce a machine readable magnetic layer.
- 12. **(Currently amended)** A method as claimed in any one of claims 1 to 10 claim 1 in which magnetic material is located in a continuous or discontinuous layer over the resist (13).
- 13. (Currently amended) A method as claimed in any one of claims 1 to 10 claim 1 in which magnetic material is located in a continuous or discontinuous layer on a second side of the polymeric film (11).
- 14. (**Currently amended**) A method as claimed in any one of the preceding claims <u>claim 1</u> in which the resist (13) comprises a plurality of different colours.
- 15. (**Currently amended**) A method as claimed in any one of the preceding claims claim 1 in which a holographic structure is incorporated.

16. (Currently amended) A method as claimed in any one of the preceding claims claim 1 in which fluorescent, luminescent and/or phosphorescent material is incorporated in the resist (13).

- 17. (Currently amended) A method as claimed in an one of the preceding claims claim 1 in which a fluorescent, luminescent and/or phosphorescent material is incorporated in the clear resist (18).
- 18. (**Currently amended**) A method as claimed in an one of the preceding claims claim 1 in which a fluorescent material is incorporated in a layer over the resist (13, 18).
- 19. (Currently amended) A method as claimed in an one-of-the preceding claims claim 1 in which a fluorescent material is incorporated in a layer on a second side of the film (11).
- 20. (Currently amended) A method as claimed in any one of the preceding claims claim 1 further accompanying the step of laminating to a second side of the film (11) a machine readable construction having a partially metallised or demetallised polymeric film (11) having a continuous strip (30) of metal (12) along each edge coincident with resist covered metal regions, in which a magnetic material is present in the continuous strips.
- 21. (Currently amended) A substrate (10) formed by the method of any one of the preceding claims claim 1.
- 22. **(Original)** A patch, foil, stripe, strip or thread formed from the substrate (10) of claim 21.
- 23. **(Original)** Security paper incorporating one or more the path, foil, stripe, strip or thread of claim 22.

24. (Original) A bank note made from the security paper of claim

23.